

## SPECIFICATION (Reference sheet)

· Supplier : Samsung electro-mechanics  
· Product : Multi-layer Ceramic Capacitor

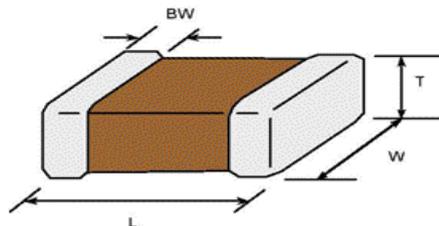
· Samsung P/N : **CL21B106KAYQNE**  
· Description : **CAP, 10 $\mu$ F, 25V,  $\pm$ 10%, X7R, 0805**

### A. Samsung Part Number

CL 21 B 106 K A Y Q N N E  
 ①    ②    ③    ④    ⑤    ⑥    ⑦    ⑧    ⑨    ⑩    ⑪

① <b>Series</b>	Samsung Multi-layer Ceramic Capacitor		
② <b>Size</b>	0805 (inch code)	L : 2.00 $\pm$ 0.20 mm	W : 1.25 $\pm$ 0.20 mm
③ <b>Dielectric</b>	X7R	⑧ <b>Inner electrode</b>	Ni
④ <b>Capacitance</b>	10 $\mu$ F	<b>Termination</b>	Cu
⑤ <b>Capacitance tolerance</b>	$\pm$ 10 %	<b>Plating</b>	Sn 100% (Pb Free)
⑥ <b>Rated Voltage</b>	25 V	⑨ <b>Product</b>	Normal
⑦ <b>Thickness</b>	1.25 $\pm$ 0.20 mm	⑩ <b>Special</b>	Reserved for future use
		⑪ <b>Packaging</b>	Embossed Type, 7" reel

### B. Structure & Dimension



Samsung P/N	Dimension(mm)			
	L	W	T	BW
CL21B106KAYQNE	2.00 $\pm$ 0.20	1.25 $\pm$ 0.20	1.25 $\pm$ 0.20	0.50 +0.20/-0.30

### C. Samsung Reliability Test and Judgement Condition

	Judgement	Test condition															
Capacitance	Within specified tolerance	1kHz ±10% / 1.0±0.2Vrms															
Tan δ (DF)	0.1 max.	*A capacitor prior to measuring the capacitance is heat treated at 150°C+0/-10°C for 1hour and maintained in ambient air for 24±2 hours.															
Insulation Resistance	10,000Mohm or 100Mohm×μF Whichever is smaller	Rated Voltage 60~120 sec															
Appearance	No abnormal exterior appearance	Microscope (×10)															
Withstanding Voltage	No dielectric breakdown or mechanical breakdown	250% of the rated voltage															
Temperature Characteristics	X7R(From -55°C to 125°C, Capacitance change should be within ±15%) below 50% of the rated voltage *Capacitance change rate = (C1-C2)/C3 C1 : Capacitance value shown in the table from step 3 to step 5 C2 : Capacitance value shown in the table at step 2 C3 : Capacitance value shown in the table at step 1																
		<table border="1"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Applying voltage(V)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>25±2</td> <td>No bias</td> </tr> <tr> <td>2</td> <td>25±2</td> <td rowspan="4">50% of the rated voltage</td> </tr> <tr> <td>3</td> <td>Min. temp.</td> </tr> <tr> <td>4</td> <td>25±2</td> </tr> <tr> <td>5</td> <td>Max. temp.</td> </tr> </tbody> </table>	Step	Temperature (°C)	Applying voltage(V)	1	25±2	No bias	2	25±2	50% of the rated voltage	3	Min. temp.	4	25±2	5	Max. temp.
Step	Temperature (°C)	Applying voltage(V)															
1	25±2	No bias															
2	25±2	50% of the rated voltage															
3	Min. temp.																
4	25±2																
5	Max. temp.																
Adhesive Strength of Termination	No peeling shall be occur on the terminal electrode	500g-f, for 10±1 sec.															
Bending Strength	Capacitance change : within ±12.5% No mechanical damage	Bending to the limit (1mm) with 1.0mm/sec.															
Solderability	More than 75% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder 245±5°C, 3±0.3sec. (preheating : 80~120°C for 10~30sec.)															
Resistance to Soldering Heat	Capacitance change : within ±7.5% Tan δ, IR : initial spec.	Solder pot : 270±5°C, 10±1sec.															
Vibration Test	Capacitance change : within ± 5% Tan δ, IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours × 3 direction (x, y, z)															
Moisture Resistance	Capacitance change : within ±12.5% Tan δ : 0.125 max IR : 500Mohm or 12.5Mohm×μF Whichever is smaller	With rated voltage 40±2°C, 90~95%RH, 500+12/-0hrs															
High Temperature Resistance	Capacitance change : within ±12.5% Tan δ : 0.125 max IR : 1,000Mohm or 25Mohm×μF Whichever is smaller	With 100% of the rated voltage Max. operating temperature 1,000+48/-0hrs															
Temperature Cycling	Capacitance change : within ±7.5% Tan δ, IR : initial spec.	1 cycle condition Min. operating temperature → 25°C → Max. operating temperature → 25°C  5 cycle test															

※ The reliability test condition can be replaced by the corresponding accelerated test condition.

### D. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260±5°C, 30sec. )



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

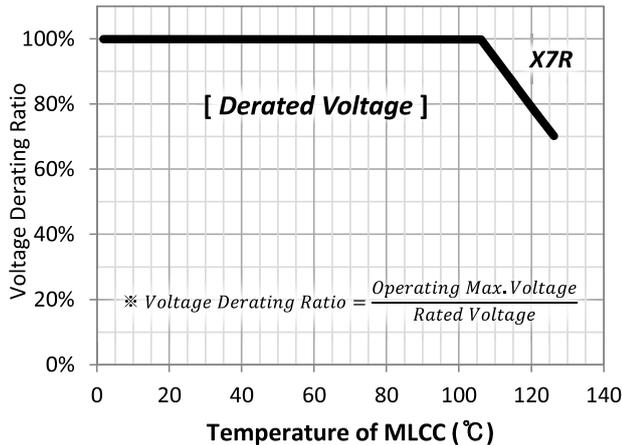
We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

## ● Derating



This product, which guarantees High Temperature Reliability Test with 100% of rated voltage at the maximum temperature, is recommended to be used in the circuit with derated voltage compared to the rated voltage of the capacitor for long lifetime.

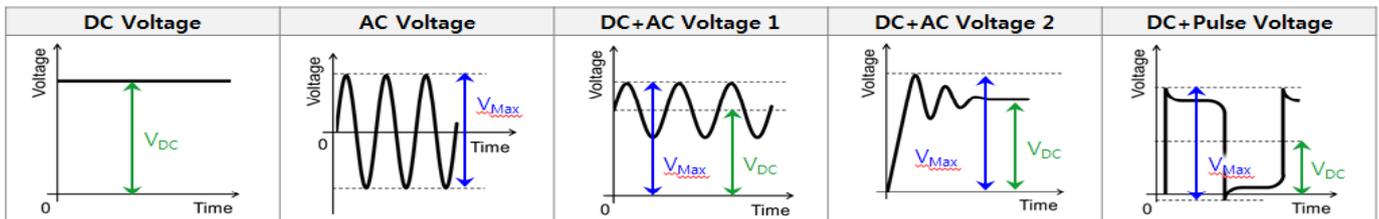
Max. voltage ( $V_{Max}$ ) and DC voltage ( $V_{DC}$ ) applied to this product shown in the table below are recommended to be used under the following conditions for long lifetime, respectively.

[Recommendations for long lifetime]

- $V_{Max} \leq$  (Derated Voltage on the left graph)
- $V_{DC} \leq 70\% \times$  (Derated Voltage on the left graph)

\* Temperature of MLCC : Surface temperature of MLCC in the circuit.

[Types of voltage applied to the capacitor]



## ● Disclaimer & Limitation of Use and Application

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- ③ Medical equipment
- ④ Military equipment
- ⑤ Disaster prevention/crime prevention equipment
- ⑥ Power plant control equipment
- ⑦ Atomic energy-related equipment
- ⑧ Undersea equipment
- ⑨ Traffic signal equipment
- ⑩ Data-processing equipment
- ⑪ Electric heating apparatus, burning equipment
- ⑫ Safety equipment
- ⑬ Any other applications with the same as or similar complexity or reliability to the applications